Amphenol Active Optics Products

NextGen Fiber Optics Transceivers

Nov 2023



Amphenol is a global manufacturer of interconnect products

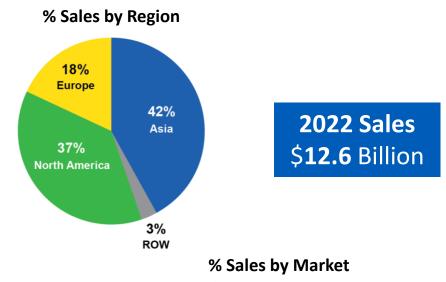


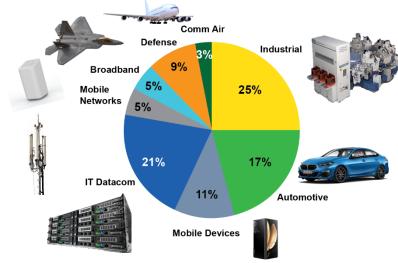
- √ 85 years history
- ✓ Net sales >B\$ 12.6
- √ 91 000+ employees worldwide
- √ 160+ facilities
- ✓ More than 100 operating units worldwide in North America, Asia, Europe, Japan, India, and Australia
- ✓ 3 Divisions

GLOBAL reach → LOCAL support

Amphenol Corporation (APH)









Amphenol Harsh Environment Solutions ("AHES") Division:



Military & Commercial Airborne



Naval



Ground Vehicles & Radar



Industrial



Space



Test & Measurement



Wireless communication

AHES provides <u>all interconnect needs</u>, from small, lightweight attachments to large, complex assemblies





AHES Product Portfolio



Circular Connectors



Rectangular & Board Level Connectors



RF Interconnects



Junction Modules Relay Sockets Terminal Blocks



Contacts & Termini



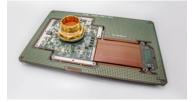
Backshells & System
Attachments



Cabling & Cable Harnesses



High Speed & Fiber Optics



Backplanes | PCBs Flex | Rigid Flex & Assemblies



Fiber Optics Onboard Transceivers & Evaluation Kits



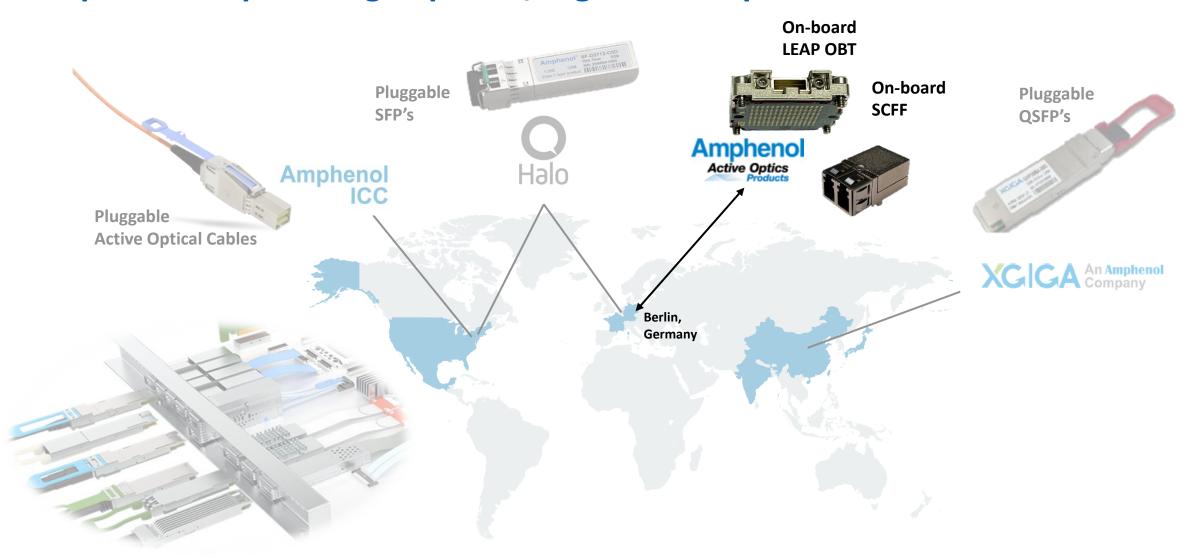


Media Converters & Ethernet Switches

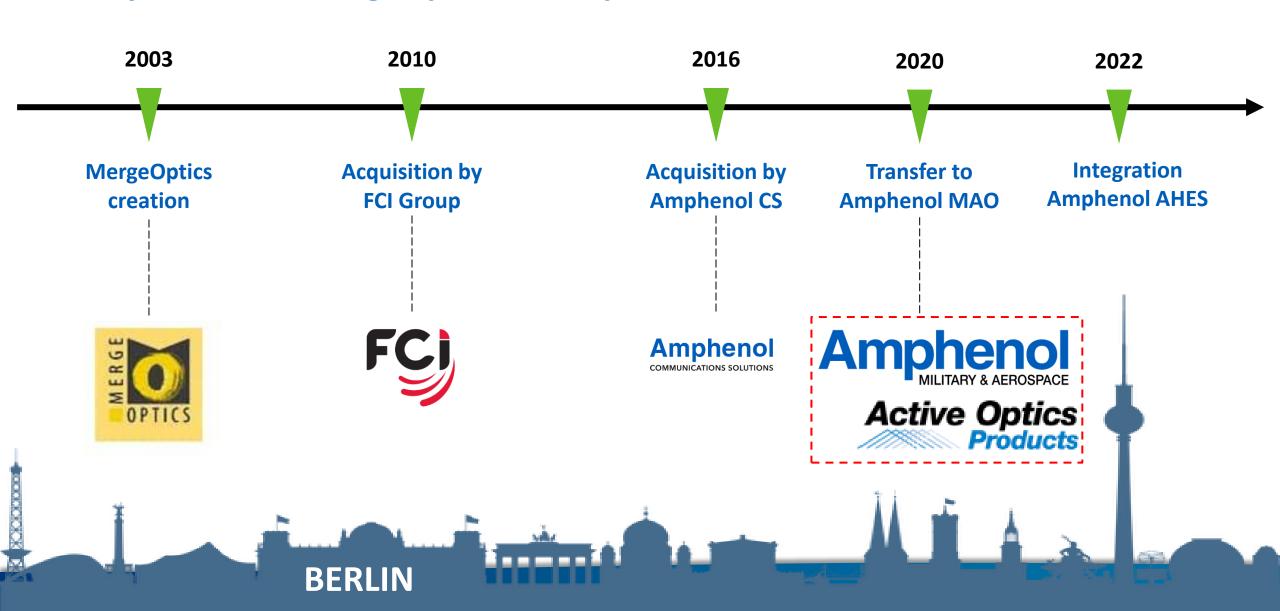


Complex Systems & Assemblies

Amphenol's optical high-speed I/O global footprint



~ 20 years from MergeOptics to Amphenol



We design and manufacture fibre optic transceivers in Berlin

Creation 2003 (Merge Optics)

- Located in Berlin, Germany
- Legal entity "FCI Deutschland GmbH"

Fiber optics transceivers

- Optical Engines for Active Optical Cables up to 28Gbps
- On Board Transceiver up to 28Gpbs

Market served

- High-Performance Computing
- Industrial instrumentation
- Military & Aerospace

Activities: ISO9001 &ISO14001

- Product Development
- Process Development
- NPI and Manufacturing

Highly Experienced Team

- 20 years of proven track record in designing and manufacturing optoelectronic products
- Core competencies in <u>RF</u>, <u>optical packaging</u>, <u>optical engine integration</u>, <u>assembly process</u>;
- Test & automation, design for manufacturability;



State of the art optical transceivers manufacturing

Manufacturing Processes

- o Die/wire bonding:
 - High accuracy die bonding (1um accuracy)
 - High speed die bonding (7um accuracy)
 - SOB, BOS, BSOB wire bonding capability
- High precision lens placement/Active alignment:
 - Fully automated, in-house engineered alignment station
 - Suitable for parallel optics (24 channels simultaneously)
- Burn-in design/testing:
 - Adaptable platform, live monitoring of critical parameters
 - Fully automated pre and post BI measurement stations
- 25Gbps testing:
 - Fully automated RF test stations for 10Gbps and 28Gbps
 - Integrated temperature controllers for fast temperature ramps (-40°C to 85°C)







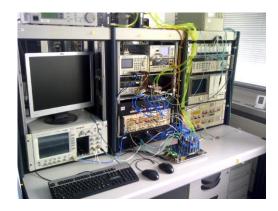
Product Development Capabilities

Product design

- Electronic design:
 - Transceivers and Active Optical Cables
 - Signal integrity: Data rates up to 28Gb/s NRZ and 56Gbd PAM4
 - PCB design, integration of components (Cadence OrCAD)
 - Connector designs for optimized signal integrity
 - Simulation (ADS, Pspice)
 - Evaluation of optical and integrated circuit for high-speed data transfer
 - Host Compliance board / Qualification board designs including GUI
- Mechanical design:
 - Die-cast design (Solidworks) (Example)
 - Tolerance analysis
 - Simulation (temperature, mechanical stress analysis)
- Optical coupling unit design:
 - Lens design for parallel optical beams
 - Mechanical design of plastic molded parts

Firmware development:

- "Mini OS" allowing transceiver to run optimally
- Monitoring/driving all the electronics on the board
- Experience with many MCU and development platforms
- Standard compliant or customized FW
- Design verification testing:
 - Performance analysis over temperature and voltage
 - From station concept to full assembly
 - Automated test software development



Amphenol Active Optics Products

Air shower

AAOP: Manufacturing Area 3x BIGGER than before

Wire-bonding

High-speed die bonding

Higher burn-in capacity



High accuracy die-bonding





Expansion: 3x production area in 2021



In-house active optical alignment

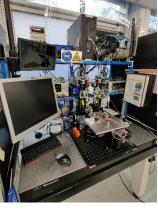


Automated RF testing



Automated DC testing











Differentiators

Portfolio

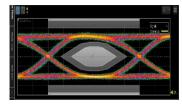
- Latest generation designs:
 - High performance
 - Safer supply chain (risk of EOL minimized)
- Extended range of data rates / channels supported:
 - Single, 4-channel, and 12-channel
 - From 1.25Gbps to 16Gbps, 28Gbps, or even 56Gbps*
 - Footprint can be re-used over several generations (QEPT platform)

Pluggability:

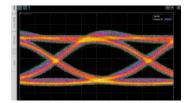
- Optical pluggability:
 - Easier/more flexible routing
 - Cost-effective replacement in case of fiber damage
- New: Hot-pluggability (QEPT platform)
 - No need to shut down system to insert/remove transceivers
 - Plug&Play solution

Thermal designs:

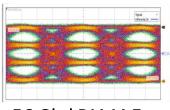
- Effective heat dissipation:
 - Heat dissipated towards the top for use of cooling plate
 - No constraints in customer board design (no dissipation inside the board)
- Effective mechanical designs:
 - Die-casted housings
 - Support customized heat-sink designs



10Gbps NRZ Eye



25Gbps NRZ Eye

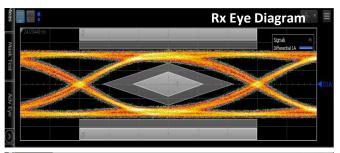


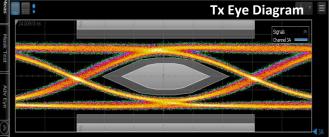
56 Gbd PAM4 Eye

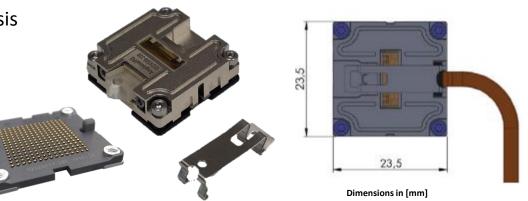
Leap® OBT |12TX+12RX| 300Gbps - COTS1

Overview:

- 12x25Gbps full duplex -> 300Gbps duplex aggregate
- Up to 100m reach with MM fiber
- 0°C to 70°C operating case temperature
- Bit error rate < 10⁻¹² (no FEC needed)
- Data rate from 300Mbps up to 28Gbps
- Power consumption:
 - 25Gbps @12TRx: 5.8W (typical)
- Accessible through two-wire serial interface
- Digital monitoring (temperature, voltage, RSSI)
- o Programmable input equalization, output amplitude, pre-emphasis
- Programmable CDR (for 25GbE operation)
- Standard MT-ferrule interface (24 fibre MT ferrule)
- Customized heat sink designs
- Fully qualified according to Telcordia standard
- Running volume production in Rev. D







Amphenol Active Optics Products

Leap® OBT - comes with no strings attached!

LEAP OBT integration on socket (4 screws)

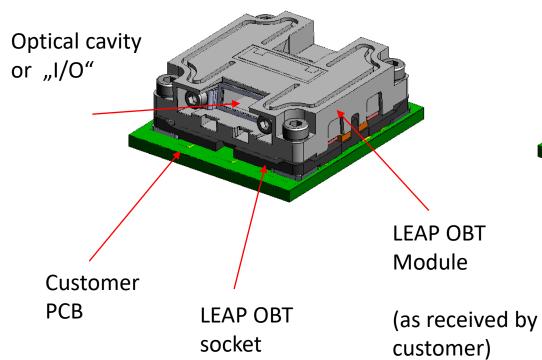
Step 1

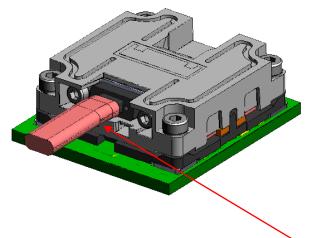
Fiber cable into optical cavity

Step 2

MT ferulle fixation with metallic clip

Step 3



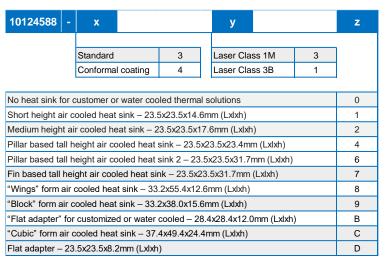


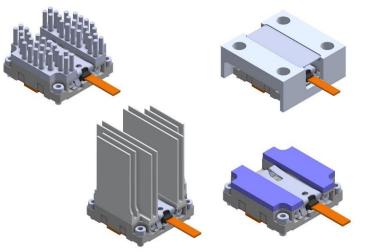
Cable to be defined by customer Can be provided by AFSI/AAO or other sister entities

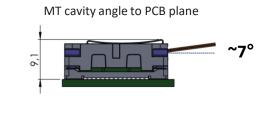


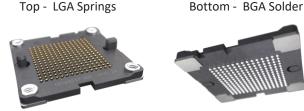
Leap® OBT p/n, heat sink options & sockets

PART NUMBER SELECTOR

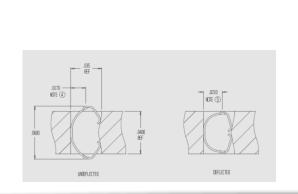


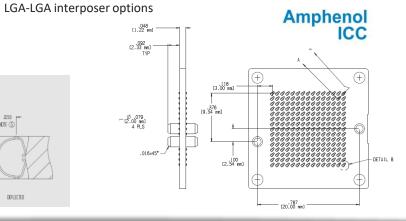






Amphenol LGA-BGA socket 10140369 (lead free or leaded)





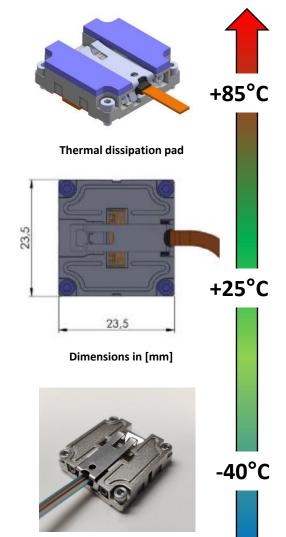
Leap® OBT |12TX+12RX| rugged optical transceiver

Product specification

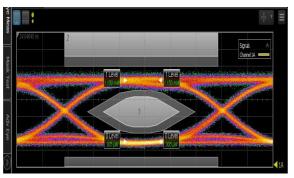
- Up to 12x16Gbps [-40°C to +85°C] (TX+RX)
- Up to 100m reach over MMF; Laser Class 1M or 3B
- -40°C to 85°C operating temperature
- MIL-STD-883: Shock Method 2002.4 (500g; 1ms), Vibe Method 2007.3 (20g sine; 20Hz-2000Hz)
- Bit error rate < 10⁻¹² (no FEC needed)
- Power consumption:
 - 10Gbps @12TRx: <3.5W</p>

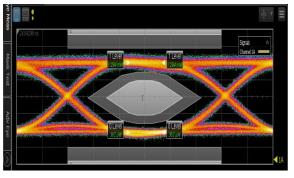
Functionalities

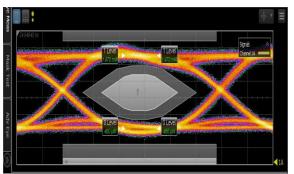
- Accessible through two-wire serial interface (I2C)
- Digital monitoring (temperature, voltage, RSSI)
- Programmable CDR (for 25GbE operation)
- Programmable input equalization, output amplitude, preemphasis
- Customized cooling design
- Standard MT-ferrule interface (24 fibre MT ferrule)



LEAP OBT rugged







Amphenol Active Optics Products

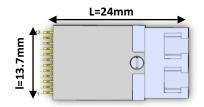
SCFF | 1TX+1RX | 25Gbps rugged optical transceiver

Product specification

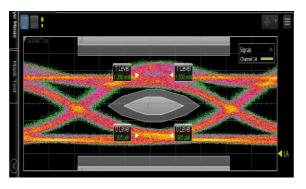
- Up to 1x25Gbps full duplex (from 1Gbps to 28Gbps)
- Up to 100m reach over MMF; Laser Class 1M or 3B
- -40°C to 85°C operating temperature
- MIL-STD-883: Shock Method 2002.4 (500g; 1ms), Vibe Method 2007.3 (20g sine)
- Bit error rate < 10-12 (no FEC needed)
- Power consumption:
 - 10Gbps @1TRx: <0.45W
 - 25Gbps @1TRx: <0.80W

Functionalities

- Accessible through two-wire serial interface (I2C)
- Digital monitoring (temperature, voltage, RSSI)
- Programmable CDR (for 25GbE operation)
- Programmable input equalization, output amplitude, preemphasis
- Die-cast housing for optimal thermal dissipation



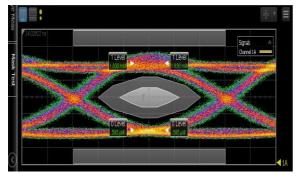


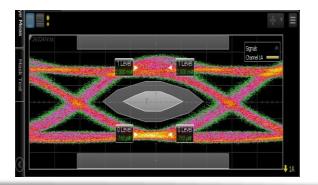


+85°C

+25°C

-40°C









Amphenol Active Optics Products

COMING SOON: QEPT 200G PAM4

Scope:

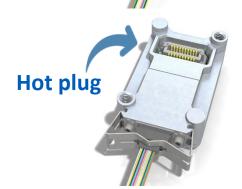
- 4-channel PAM4 56Gbps TRX
- Commercial temperature (0°C to 70°C)
- Platform re-usable for 28Gbps extended temperature TRX

Performance (targets):

- BER < 10-12 at @ 26.5625GBaud/s < 2.4E-4
- Power consumption below 3W
- Backward compatibility for 28Gbps NRZ

Mechanical features (targets):

- 26 x 18 x 8 mm effective PCB area used of 180 mm²
- Thermal dissipation towards flat top
- Optically and electrically hot pluggable







ECOC 2023 AAOP DEMONSTRATOR



ALSO AVAILABLE IN 100G NRZ

Scope:

- 4-channel NRZ 28Gbps TRX | 8-channel NRZ 28 Gbps Tx or Rx
- Extended temperature (-40°C to 85°C)
- Platform re-usable for 56Gbps PAM4

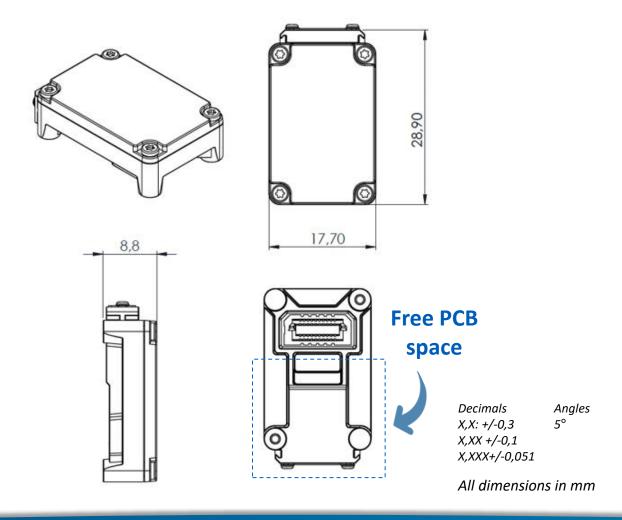
Performance (targets):

- BER < 10-12 at @ 25.78 Gbps below 10-12
- Power consumption below 2W
- Upward compatibility for 56Gbps PAM4

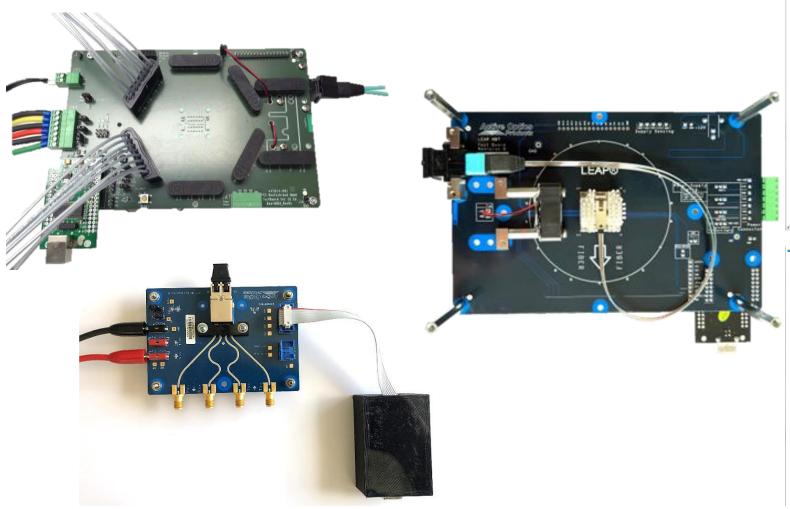
Mechanical features (targets):

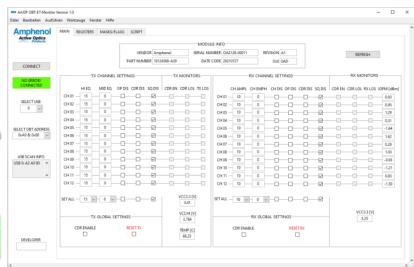
- 26 x 18 x 8 mm effective PCB area used of 180 mm²
- Thermal dissipation towards flat top
- Optically and electrically hot pluggable

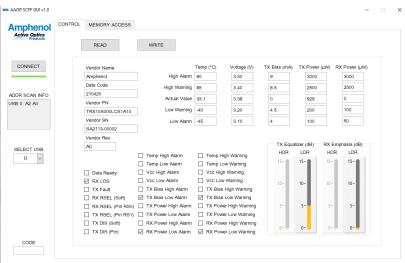




Transceivers Evaluation Kits







Rugged Active Optical Cable

Product specification

- Transmit high speed 5Gbps / 10Gbps differential pair protocols over fiber (Board ethernet, USB3 SuperSpeed)
- Up to 200m reach over MMF
- -40°C to 85°C operating temperature, Dust
- MIL-STD-883: Shock Method 2002.4 (500g; 1ms), Vibe
 Method 2007.3 (20g)
- Bit error rate < 10-12 (no FEC needed)
- Hi Rel. Amphenol SOCAPEX TVUCom connector
- Turret (optional)

Applications:

- C5ISR tactical deployment
- Airborne HEFO needs

Adaptations possible:

- Board level ethernet
- SD/HD/3G/6G SDI video transmission
- D-Sub & Micro-D with Positronic products





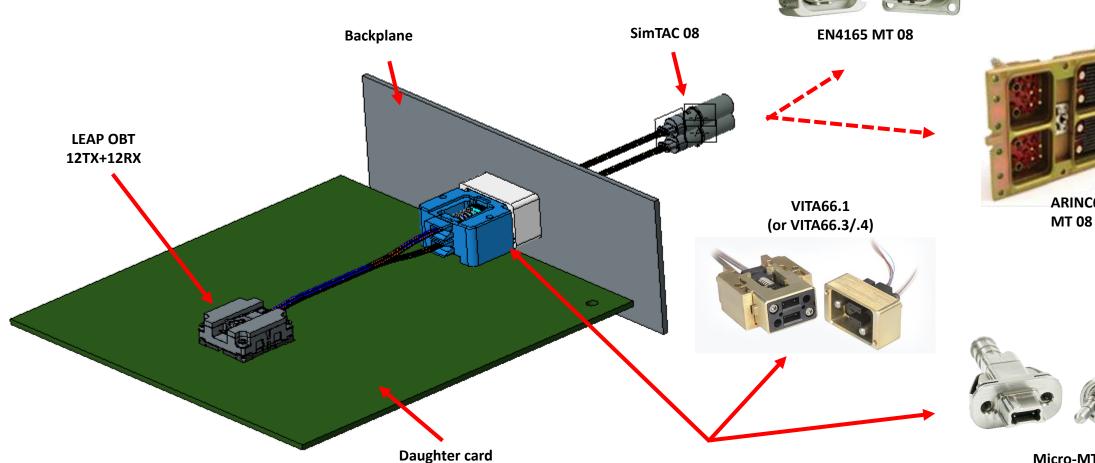






AHES fiber optics end-to-end solutions

- w/ rugged rectangular inter-connects







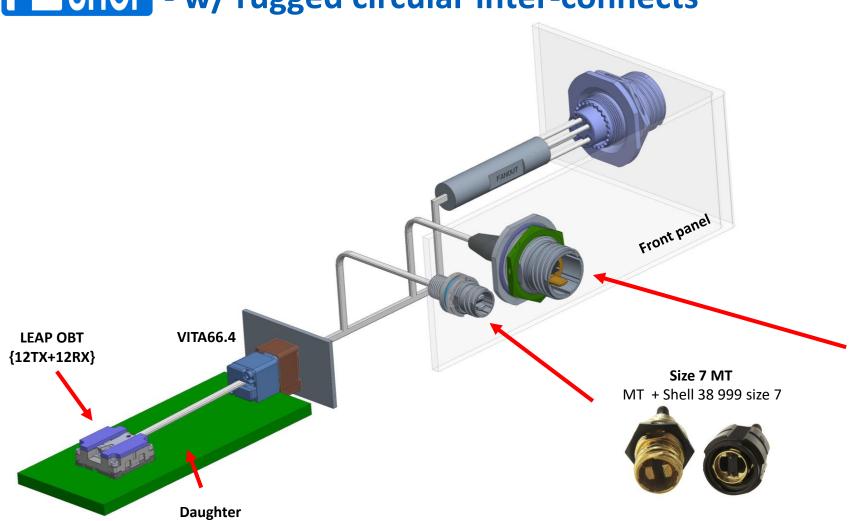
Micro-MT



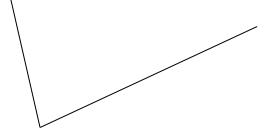
card



ONE STOP AHES fiber optics end-to-end solution SHOP - w/ rugged circular inter-connects **AHES fiber optics end-to-end solutions**







MPO field MPO + Shell 38 999 size 13









AHES integrates both RF & optics into VITA

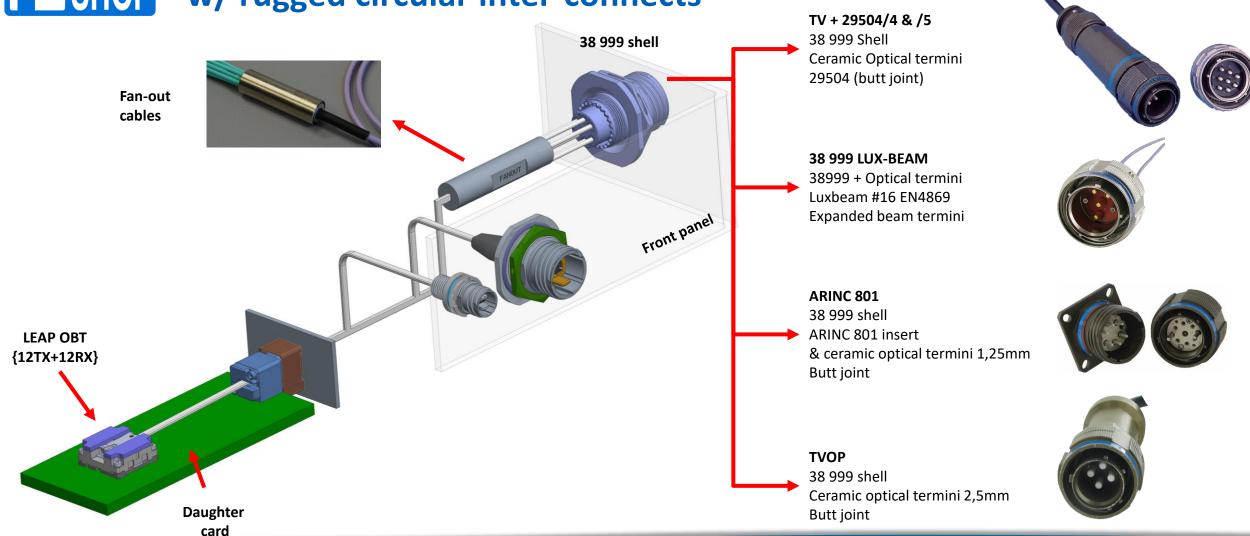


- VITA 67 contain RF and Fiber hybrid for first time
 - Amphenol collaborative demo kit
- Support for 3 (2 x 24) fiber channels and 19 RF
 - Current draft in VITA 66.5 limits MT locations
- A product of:
 - SV microwave
 - Amphenol Aerospace
 - Amphenol FSI
 - Amphenol Active Optics products

Amphenol ONE STOP SHOP

AHES fiber optics end-to-end solutions

- w/ rugged circular inter-connects

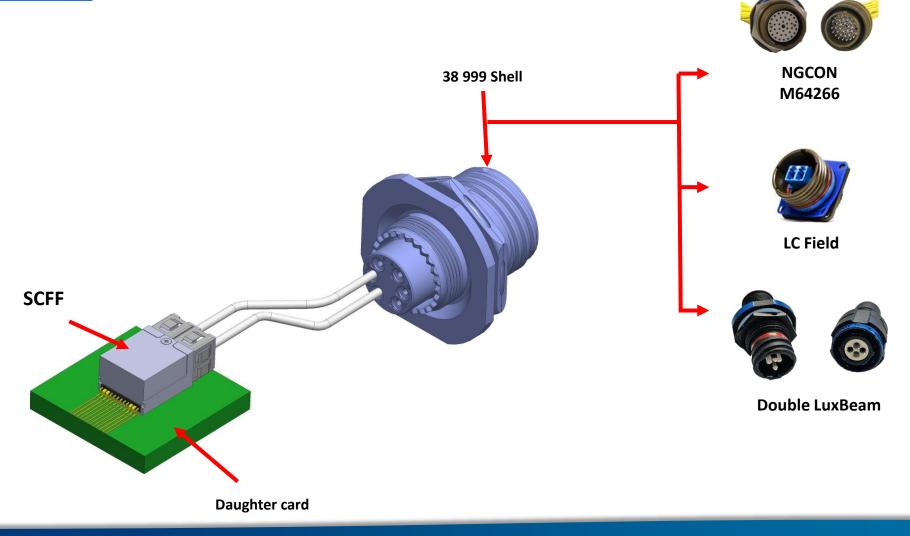




ONE STOP SHOP

AHES fiber optics end-to-end solutions

- SCFF based examples







AHES fiber optics end-to-end solutions

- w/ harsh environment FO cabling solutions

THDM to MTP
24 Channels crossover

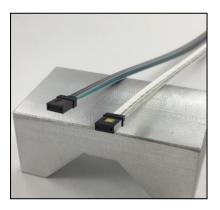


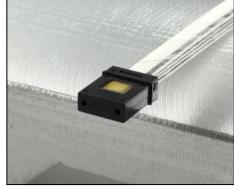




MT38999 to M29504/04 Short Fanout assembly













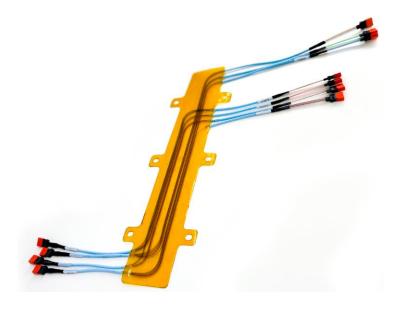
MT Ferrule 48Channels Termination capabilities

MT38999 to FC connector
Loop back (2 channels) + right angle backshell





AHES fiber optics end-to-end solutions - Optical Flex Planes -





Product specification

- Ideal for high density applications
- Can be designed for routing around Board Level components
- Improves Airflow for cooling vs Traditional cable approach
- Temp Range -55 to +95C
- Flame resistant substrate



Contact

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